

# LC8905V

## **Digital Audio Interface Receiver**

### **Preliminary**

#### Overview

The LC8905V is for use in IEC 958 and EIAJ CP-1201 format data transmission between digital audio equipment. This LSI is used on the receiving side, and handles synchronization with the input signal and demodulation of that signal to a normal format signal.

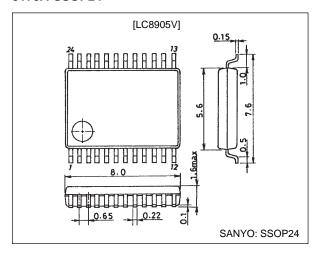
#### **Features**

- On-chip PLL circuit synchronizes with the transmitted IEC 958 and EIAJ CP-1201 format signal.
- Provides 128fs, bit, and L/R clock outputs.
- System clock can be selected to be either 384fs or 512fs.
- Microprocessor interface code settings for different output types
  - Input pin, emphasis output, input bi-phase data output, and validity flag output settings
- Audio data output format setting
- Channel status output (32-bit output for consumer products)
- Subcode Q output with CRC flags (80 bits)
- Start ID and shortening ID detection for DAT (Digital Audio Tape recorder) that use subcodes
- CMOS, single-voltage power supply
- Miniature package: SSOP-24

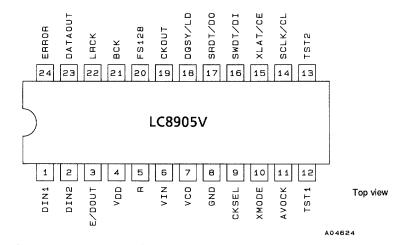
# **Package Dimensions**

unit: mm

#### 3175A-SSOP24



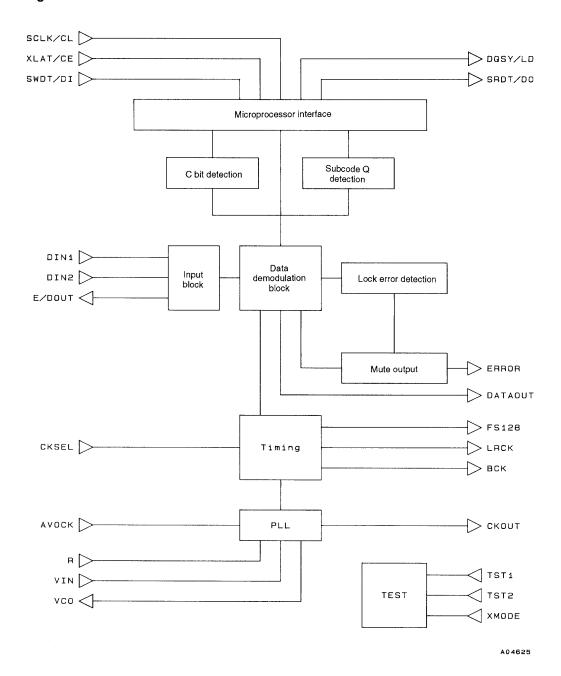
### **Pin Assignment**



### **Pin Functions**

Pin No.	Symbol	I/O	Description			
1	DIN1	ı	Data input with built-in amplifier (for coaxial or optical module input)			
2	DIN2	I	Data input (for optical module input)			
3	E/DOUT	0	Emphasis, input bi-phase, and validity flag output			
4	V <sub>DD</sub>		Power supply			
5	R	I	VCO gain control input			
6	VIN	I	VCO free-running setting input			
7	VCO	0	PLL low-pass filter setting			
8	GND		Ground			
9	CKSEL	- 1	System clock selection input (384fs or 512fs)			
10	XMODE	I	Reset input			
11	AVOCK	I	PLL error lock avoidance clock input			
12	TST1	I	Test input (Must be connected to ground in normal operation)			
13	TST2	I	Test input (Must be connected to ground in normal operation)			
14	SCLK/CL	I	Microprocessor interface clock input			
15	XLAT/CE	1	Microprocessor interface latch/chip enable input			
16	SWDT/DI	- 1	Microprocessor interface write data input			
17	SRDT/DO	0	Microprocessor interface read data output			
18	DQSY/LD	0	Microprocessor interface subcode Q and ID synchronization output			
19	CKOUT	0	VCO clock output (free running, 384fs, or 512fs)			
20	FS128	0	128fs clock output			
21	BCK	0	Bit clock output			
22	LRCK	0	L/R clock output (left channel = high, right channel = low)			
23	DATAOUT	0	Audio data output			
24	ERROR	0	PLL lock error mute output			

#### **Block Diagram**



# **Specifications**

### Absolute Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V <sub>DD</sub> max		-0.3 to +7.0	V
Maximum I/O voltages	V <sub>I</sub> V <sub>O</sub> max		-0.3 to V <sub>DD</sub> + 0.3	V
Operating temperature	Topr		-30 to +75	°C
Storage temperature	Tstg		-55 to +125	°C

### **Allowable Operating Ranges**

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	V <sub>DD</sub>		4.5	5.0	5.5	V

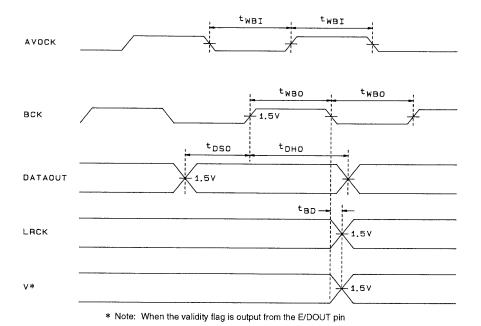
### **Electrical Characteristics**

# DC Characteristics at Ta = –30 to +75°C, $V_{DD}$ = 4.5 to 5.5 V, $V_{SS}$ = 0 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Input high-level voltage	V <sub>IH</sub> 1	Applies to the DIN2 pin. TTL levels	2.2		V <sub>DD</sub> + 0.3	V
Input low-level voltage	V <sub>IL</sub> 1	Applies to the DIN2 pin. TTL levels	-0.3		+0.8	V
Input high-level voltage	V <sub>IH</sub> 2	Applies to the CKSEL, AVOCK, TST1, and TST2 pins. CMOS levels	0.7 V <sub>DD</sub>		V <sub>DD</sub> + 0.3	V
Input low-level voltage	V <sub>IL</sub> 2	Applies to the CKSEL, AVOCK, TST1, and TST2 pins. CMOS levels	-0.3		0.3 V <sub>DD</sub>	V
Input high-level voltage	V <sub>IH</sub> 3	Applies to the XMODE, SCLK/CL, XLAT/CE, SWDT/DI pins. CMOS Schmitt inputs	0.8 V <sub>DD</sub>		V <sub>DD</sub> + 0.3	V
Input low-level voltage	V <sub>IL</sub> 3	Applies to the XMODE, SCLK/CL, XLAT/CE, SWDT/DI pins. CMOS Schmitt inputs	-0.3		0.2 V <sub>DD</sub>	V
Input high-level voltage	V <sub>OH</sub>	$I_{OH} = -1 \mu A$	V <sub>DD</sub> – 0.05			V
Input low-level voltage	V <sub>OL</sub>	I <sub>OL</sub> = 1 μA			V <sub>DD</sub> + 0.05	V
Current drain	I <sub>DD</sub>	V <sub>DD</sub> = 5.0 V, Ta = 25°C, input data fs = 48 kHz		10	15	mA
Input amplitude	Vpp	Measured before the DIN1 pin input capacitor.	0.4		V <sub>DD</sub> + 0.3	V

# AC Characteristics at $Ta = -30 \ to \ +75^{\circ}C, \ V_{DD} = 4.5 \ to \ 5.5 \ V$

Parameter	Symbol	Conditions	min	typ	max	Unit
Input pulse width	t <sub>WBI</sub>		10			μs
Output pulse width	t <sub>WBO</sub>	fs = 48 kHz	160			ns
Output data setup time	t <sub>DSO</sub>		80			ns
Output data hold time	t <sub>DHO</sub>		80			ns
Output delay	t <sub>BD</sub>		-10	0	+10	ns



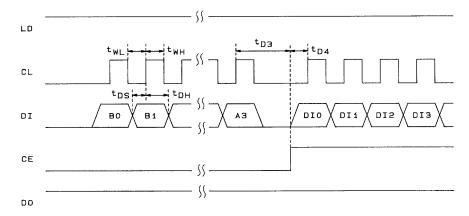
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### **Microprocessor Interface Block AC Characteristics**

# at Ta = -30 to +75°C, $V_{DD}$ = 4.5 to 5.5 V (when CKSEL is low)

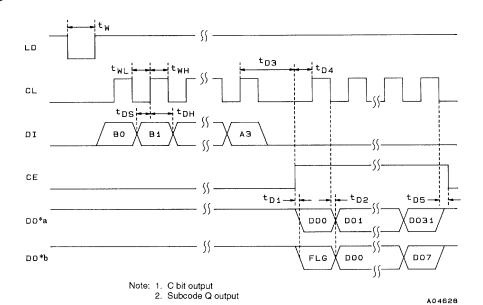
Parameter	Symbol	Conditions	min	typ	max	Unit
CL low pulse width	t <sub>WL</sub>		100			ns
CL high pulse width	t <sub>WH</sub>		100			ns
Data setup time	t <sub>DS</sub>		50			ns
Data hold time	t <sub>DH</sub>		50			ns
CE delay time	t <sub>D3</sub>		1.0			μs
CL delay time	t <sub>D4</sub>		50			ns
CE delay time	t <sub>D5</sub>				100	ns
LD pulse width	t <sub>W</sub>	fs = 44.1 kHz		136		μs
Data delay time	t <sub>D1</sub>	CL = 30 pF			75	ns
Data delay time	t <sub>D2</sub>	CL = 30 pF			75	ns

### Input mode



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### Output mode

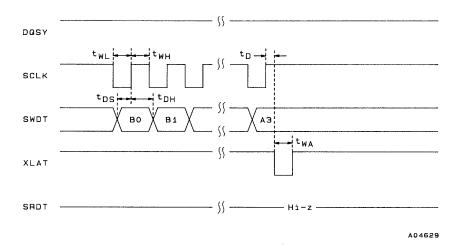


# **Microprocessor Interface Block AC Characteristics**

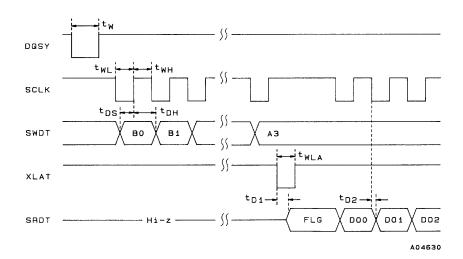
at Ta = -30 to  $+75^{\circ}$ C,  $V_{DD}$  = 4.5 to 5.5 V (when CKSEL is high)

Parameter	Symbol	Conditions	min	typ	max	Unit
CL low pulse width	t <sub>WL</sub>		100			ns
CL high pulse width	t <sub>WH</sub>		100			ns
Data setup time	t <sub>DS</sub>		50			ns
Data hold time	t <sub>DH</sub>		50			ns
CE delay time	t <sub>D</sub>		100			μs
LD pulse width	t <sub>W</sub>	fs = 44.1 kHz		136		μs
Data delay time	t <sub>D1</sub>	CL = 30 pF			75	ns
Data delay time	t <sub>D2</sub>	CL = 30 pF			75	ns

### Input mode



### Output mode



#### LC8905V

#### **Functions**

1. Data Input and Output (DIN1, DIN2, E/DOUT)

The DIN1 pin has a built-in amplifier, and can receive signals with an amplitude of about 400 mVp-p (coaxial input). The DIN2 pin is only for use with optical modules.

Note that although the data input pins are controlled by the microprocessor, DIN1 can be selected when a microprocessor is not used. The microprocessor interface pins must be tied low in such applications.

The E/DOUT normally outputs channel status information. However, it can be set to output either the input bi-phase data or the validity flag by command codes from the microprocessor.

2. PLL (R, VIN, VCO, AVOCK)

This circuit includes a built-in VCO and supports sampling frequencies of 32, 44.1, and 48 kHz.

The resistor connected to R functions as both the VCO gain control and as temperature compensation. The VIN pin sets the VCO free-running frequency.

The PLL circuit can be reset within a fixed period when it operates incorrectly, for example, if a lock pull-in failure occurs, by inputting an asynchronous, continuously operating clock signal to the AVOCK pin.

3. Clock Settings and Output (FS128, BCK, LRCK, DATAOUT, CKSEL, CKOUT)

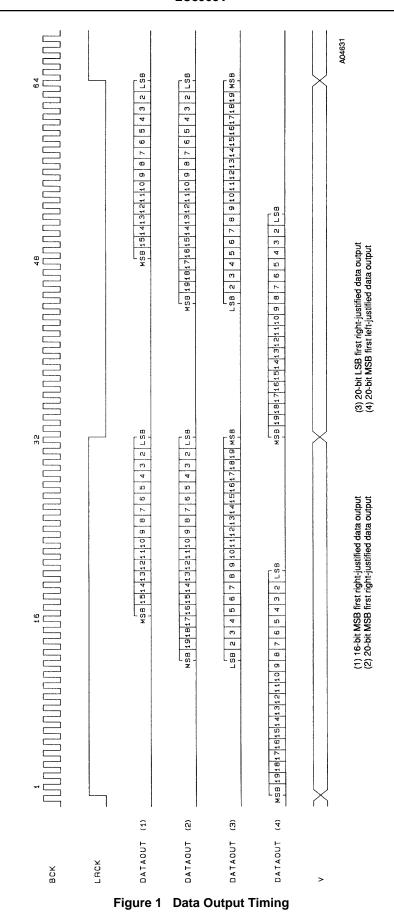
A 128fs clock signal is output from the FS128 pin. Figure 1 shows the output timing for the BCK, LRCK, and DATAOUT pins.

The CKOUT clock output is set by the CKSEL pin as listed in the table below.

CKSEL	CKOUT
L	384fs clock output
Н	512fs clock output

The microprocessor interface format is also set by CKSEL as listed in the table below.

CKSEL	Microprocessor interface
L	Figure 2
Н	Figure 3



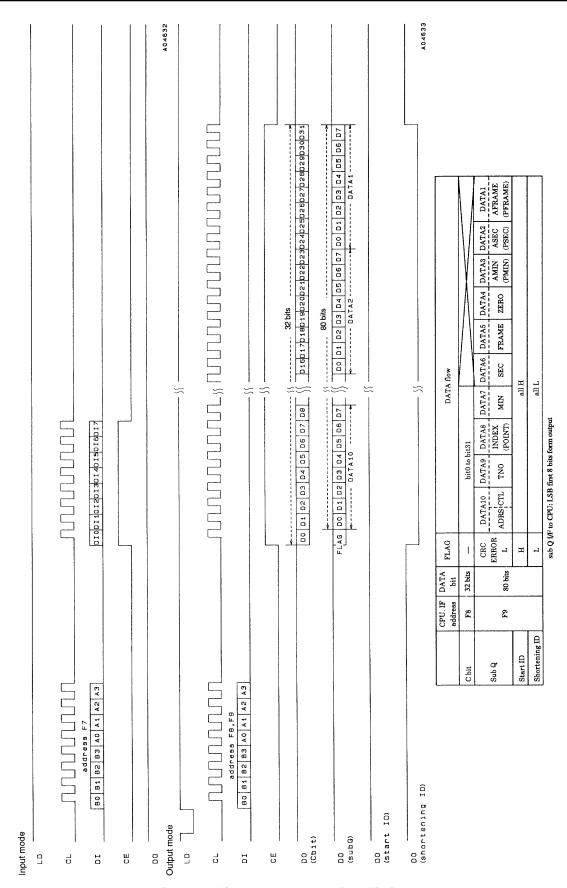


Figure 2 Microprocessor Interface Timing 1

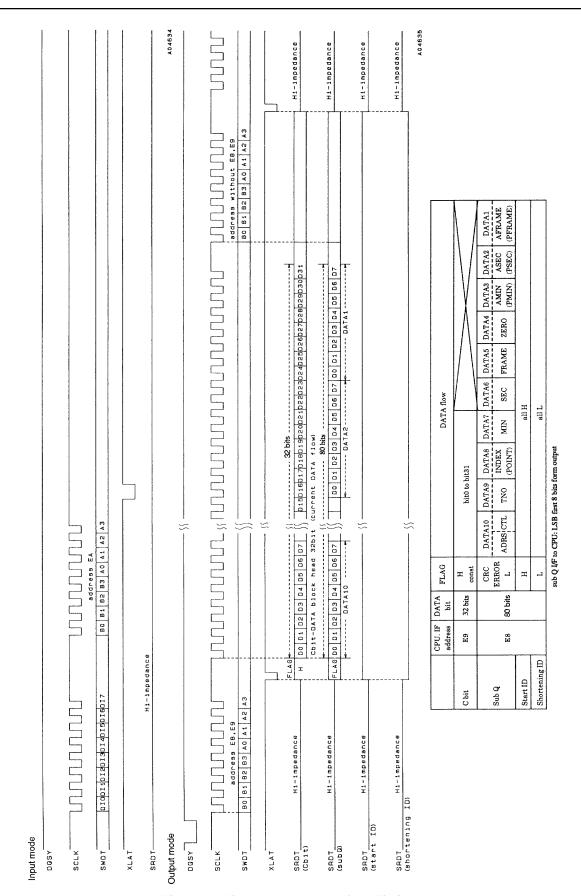


Figure 3 Microprocessor Interface Timing 2

### Microprocessor Interface (SCLK/CL, XLAT/CE, SWDT/DI, SRDT/DO, DQSY/LD)

1. Data input and output addresses are allocated as follows:

Data input or output		Figure	2: Mi	cropro	cessor	Interfa	ace Tin	ning 1		Figure 3: Microprocessor Interface Timing 2								
Data input or output		B0	B1	B2	В3	A0	A1	A2	А3		B0	B1	B2	В3	A0	A1	A2	А3
Data input	F7	1	1	1	0	1	1	1	1	EA	0	1	0	1	0	1	1	1
C bit output	F8	0	0	0	1	1	1	1	1	E9	1	0	0	1	0	1	1	1
Subcode Q, ID output	F9	1	0	0	1	1	1	1	1	E8	0	0	0	1	0	1	1	1

- 2. The input command codes control the following settings:
  - System stop
  - Data input pin settings
  - Input bi-phase data output selection
  - Validity flag output selection
  - · Audio data output format setting

DI1: Stops VCO operation and thus stops the system.

DI1	L	Н
System	Operating	Stopped

DI2: Selects which input data to demodulate.

DI2	L	Н
Data demodulation input	DIN1	DIN2

DI3 and DI4: Select the E/DOUT pin output.

DI3	L		Н		
DI4	L	Н	L	Н	
E/DOUT	Emphasis data output	Validity flag output	DIN1 input data output	DIN2 input data output	

DI5 and DI6: Set the audio data output format.

DI5	L		Н		
DI6	L	Н	L	Н	
DATAOUT	16-bit right- justified MSB first	20-bit right- justified LSB first	20-bit right- justified MSB first	20-bit left- justified MSB first	

All bits are set low immediately after XMODE is switched from low to high. DIO and DI7 are not used.

- 3. The following output settings can be controlled:
  - Channel status (C bit) output
  - Subcode Q data output
  - Status ID and shortening ID detection for DAT that use subcodes

#### C bit output

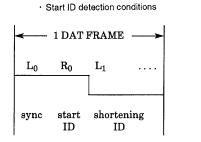
- This function presumes that this IC will be used in consumer mode and thus only handles the first 32 bits.
- The flag is fixed at the high level (although there is no flag in the type 1 microprocessor interface timing), and the data format is LSB first.
- Error and update checking is not applied to the data.
- The internal shift register is reset if a PLL lock error occurs.
- An interval of at least 6 msec must be provided between consecutive data readout operations.

#### Subcode Q output

- Subcode Q can be read out after the fall of the DQSY/LD signal. Also note that the data is updated every time this signal falls. However, this signal will not be output (fall) unless 96 bits of subcode Q data (include the CRC check bits) is input.
- The flag outputs a high when the CRC check passes, and low if the CRC check fails.
- The bit order is LSB first within each byte of the 80 bits of subcode Q data.

#### ID detection

- The start ID and shortening ID are only detected when the DAT category code (1100000L) is received.
- These IDs are detected as follows:
  - A low pulse is output from DQSY/LD if a start ID (R<sub>0</sub>) or a shortening ID (L<sub>1</sub>) is detected following a sync signal (L<sub>0</sub>).
  - After this signal, data can be read out from SRDT/DO by inputting the same address value as that used for subcode Q data to SWDT/DI.



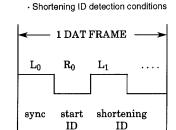


Figure 4 User Data for DAT that Use Subcodes

• The table below shows the relationship between the sync signal  $(L_0)$ , the start ID  $(R_0)$ , the shortening ID  $(L_1)$ , and the data output.

(L <sub>0</sub> ): SYNC	Н	Н
(R <sub>0</sub> ): Start ID	Н	L
(L <sub>1</sub> ): Shortening ID	L	Н
Flags + 80 data bits	all H	all L
Detected ID	Start ID	Shortening ID

#### • Output pins

The output scheme used for SRDT/DO differs depending on the microprocessor interface format selected by CKSEL.

CKSEL	Format	SRDT/DO		
L	Figure 2	Open-drain output		
Н	Figure 3	Three-state output		

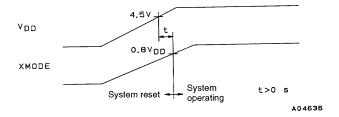
#### Error (ERROR)

The ERROR pin goes high if there is an error in the input data or if the PLL is unlocked. It holds the high level for about 200 to 300 msec after data demodulation returns to normal and then goes low. The table below lists the data processing when an error has occurred.

Type of error	DATAOUT	C bit	Sub Q	ID	E/DOUT
Up to 8 consecutive parity errors	Previous data value	Output	Output	Output	Output
Over 8 consecutive parity errors	L	Output	Output	Output	Output
PLL lock error	L	L	L	L	L

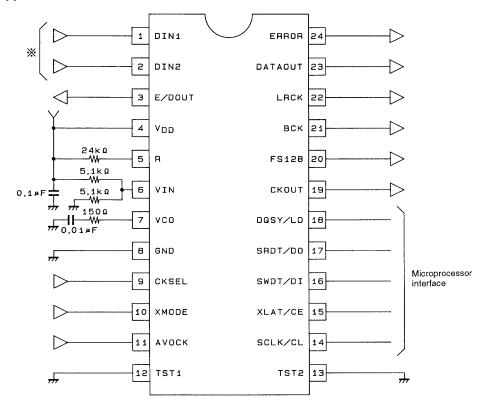
### System Reset (XMODE)

Normal system operation is started by setting XMODE high after the power supply has risen above at least 4.5 V. If XMODE is set low, the VCO free-running oscillator clock is output from CKOUT.

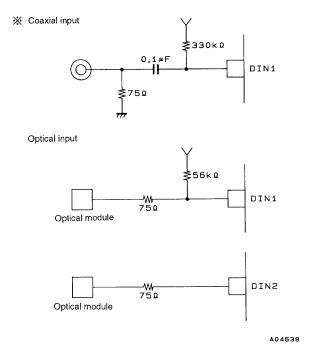


Setting XMODE low once again after power on resets the system.

### **Sample Application Circuit**



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#### LC8905V

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